AMENDMENTS TO THE ABSTRACT

Please amend the abstract as follows:

An electrically conductive paste used for forming wiring conductors, such as via holes (15) disposed on a multilayer ceramic substrate (11), is provided, wherein the temperature range[[,]] in which sintering is effected in a firing step[[,]] can be controlled relatively optimally. The electrically conductive paste contains a metal powder, a grass glass frit, and an organic vehicle. An inorganic component, which is not sintered at a sintering temperature capable of sintering the ceramic layers (12)-included in the multilayer ceramic substrate (11)-in the firing step, is disposed on particle surfaces of the metal powder. The glass frit has a softening point 150°C to 300°C lower than the above-described sintering temperature.